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## Implementation of WIPO Standard ST.91

Identification page	
Please enter the ST.3 code and name of the member state or international organization you represent.  *	
Please enter the name of the office or organization you represent. For instance, Canadian Intellectual Property Office.  If your organization name is the same as your ST.3 code name, you may put "n/a". *	
Please enter your email address so we can contact you if we have questions about your response. *	
Questions page Q 1. Does your Office currently use 3D models, 3D images or 3D chemical structures?	
C Yes C No C Other (please specify)	

☐ Trademarks ☐ Industrial Designs ☐ Inventions ☐ Utility models ☐ Integrated circuit topology ☐ Other (please specify) ☐ Yes, fully ☐ Partially ☐ No ☐ Additional Comments	
□ Inventions □ Utility models □ Integrated circuit topology □ Other (please specify) □ Q 1.2. Does your Office implement WIPO Standard ST.91 within its work?  * □ Yes, fully □ Partially □ No	Trademarks
□ Utility models □ Integrated circuit topology □ Other (please specify) □ 1.2. Does your Office implement WIPO Standard ST.91 within its work?  * Yes, fully □ Partially □ No	Industrial Designs
☐ Integrated circuit topology ☐ Other (please specify)  Q 1.2. Does your Office implement WIPO Standard ST.91 within its work?  *  ☐ Yes, fully ☐ Partially ☐ No	Inventions
Other (please specify)  Q 1.2. Does your Office implement WIPO Standard ST.91 within its work?  Yes, fully Partially No	Utility models
Q 1.2. Does your Office implement WIPO Standard ST.91 within its work?  *  Yes, fully  Partially  No	Integrated circuit topology
*  □ Yes, fully □ Partially □ No	Other (please specify)
*  □ Yes, fully □ Partially □ No	
□ No	
□ No	
	Yes, fully
Additional Comments	
	Partially
	Partially No

1. Q 1.1. If yes, for what IP rights:

Q 2.1. What formats of 3D models, 3D images or 3D chemical structures does your Office currently accept for each IP right?

	Trademarks	Industrial Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)
None, my Office doesn't operate this type of IP right						
None, my Office doesn't accept 3D models, 3D images or 3D chemical structures for this type of IP right	П	П				П
3D PDF						
IGES						
OBJ						
STL						
STEP/STP						
U3D						
MOL						
CDX						
Other (please specify)						

chem	<ol> <li>What software does your nical structures during the se specify:</li> </ol>		ization of 3D mode	els, 3D images or 3	3D

Q 2.3. What formats of 3D models, 3D images or 3D chemical structures does your Office currently use for the electronic publication for each IP right operated by Office?

	Trademarks	Industrial Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)
None, my Office doesn't operate this type of IP right						
None, my Office doesn't publish information of this type of IP right electronically	П	П				П
None, my Office doesn't publish information of 3D models, 3D images or 3D chemical structures electronically even if they were accepted						
2D images received by my Office from the source 3D models or 3D images						
3D PDF						
IGES						
OBJ						
STL						
STEP/STP						
U3D						
MOL						
CDX						
Other (please specify)						

Q 2.4. What software does your or 3D chemical structures? Please specify:	Office currently	y use for the	e electronic p	ublication	of 3D mode	ls, 3D image
Q 2.5. What formats of 3D mode he paper publication for each IP	_	or 3D chen	nical structure	es does y	our Office cu	rrently use fo
	Trademarks	Industrial Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology	Inventions (3D chemical structures)
None, my Office doesn't operate this type of IP right						
None, my Office doesn't publish information of this type of IP right on paper	П					
None, my Office doesn't publish information of 3D models, 3D images or 3D chemical structures on paper even if they were accepted						
2D images received by Office from the source 3D models or 3D images						
Link to the 3D object online						
Other (please specify)						

	.6. Does your Office carry out searc dels and 3D images during the exan	•			•	
		Trademarks	Industrial Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology
	No					
	Yes, my Office uses 2D representations of 3D models for the comparison			п		П
	Yes, my Office uses 3D models themselves for the comparison					
	Other (please specify)					
with	.7. What software does your Office of 3D models and 3D images during the lease specify:		-	arison of the 3D m	nodels and	3D images

Q 2.8. Does your Office carry out search for the comparison of the 3D models and 3D images with 2D images during the examination process and if so, in what formats for each IP rights?					
	Trademarks	Industrial Designs	Inventions (except 3D chemical structures)	Utility models	Integrated circuit topology
No					
Yes, my Office uses 2D representations of 3D models for the comparison					П
Yes, my Office uses 3D representations of 2D images for the comparison					
Other (please specify)					
Q 2.9. What software does your Office curre with <b>2D images</b> during the examination pro		compariso	n of the 3D mo	odels and	3D images
Q 3.1. Please describe existing practices or structures within your Office	future plans fo	r using 3D r	nodels, 3D im	ages or 3	D chemical

Q 3.2. Please describe existing practices or future plans relating t ST.91 within your Office	o the implementation of WIPO Standard
Q 4. Any other comments Please specify:	